# AIC1730

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150mA, Low Noise, Low Dropout Linear Regulator

# **FEATURES**

- Very Low Quiescent Current, 55µA
- Very Low Dropout Voltage, 90mV @ 50mA.
- Short Circuit and Thermal Protection.
- Available in  $\pm 2\%$  Output Tolerance.
- 1.8V to 3.3V Output Voltage with 0.1V Increment.
- Active Low Shutdown Control.
- Low Noise.
- Low Profile Package: SOT-23-5

# **APPLICATIONS**

- Cellular Telephones.
- Pagers.
- Personal Communication Equipment.
- Cordless Telephones.
- Portable Instrumentation.
- Portable Consumer Equipment.
- Radio Control Systems.
- Low Voltage Systems.
- Battery Powered Systems.

# **TYPICAL APPLICATION CIRCUIT**

### DESCRIPTION

The AIC1730 is a low noise, low dropout linear regulator, and is housed in a small SOT-23-5 package. The device is in the "ON" state when the SHDN pin is set to logic high level. A low dropout voltage of 90mV at 50mA load current is performed. It offers high precision output voltage of  $\pm 2\%$ . The quality of low quiescent current and low dropout voltage makes this device ideal for battery power applications. The internal reverse bias protection eliminates the requirement for a reverse voltage protection diode. The high ripple rejection and low noise provide enhanced performance for critical applications. The noise bypass pin can be connected an external capacitor to reduce the output noise level.



Low Noise Low Dropout Linear Regulator



# ORDERING INFORMATION





The output voltage is available by 0.1V per step.

Example: AIC1730-18CVTR

 $\rightarrow$  1.8V version in SOT-23-5 Package & Taping & Reel Packing Type

AIC1730-18PVTR

 $\rightarrow~$  1.8V version in SOT-23-5 Lead Free Package & Taping & Reel Packing Type AIC1730-18GVTR

→ 1.8V version in SOT-23-5 Green Package & Taping & Reel Packing Type

Part No.	CV	PV	GV
AIC1730-18	EC18	EC18P	EC18G
AIC1730-19	EC19	EC19P	EC19G
AIC1730-20	EC20	EC20P	EC20G
AIC1730-21	EC21	EC21P	EC21G
AIC1730-22	EC22	EC22P	EC22G
AIC1730-23	EC23	EC23P	EC23G
AIC1730-24	EC24	EC24P	EC24G
AIC1730-25	EC25	EC25P	EC25G
AIC1730-26	EC26	EC26P	EC26G

#### • SOT-23-5 Marking

Part No.	CV	PV	GV
AIC1730-27	EC27	EC27P	EC27G
AIC1730-28	EC28	EC28P	EC28G
AIC1730-285	EC2J	EC2JP	EC2JG
AIC1730-29	EC29	EC29P	EC29G
AIC1730-30	EC30	EC30P	EC30G
AIC1730-31	EC31	EC31P	EC31G
AIC1730-32	EC32	EC32P	EC32G
AIC1730-33	EC33	EC33P	EC33G



# ■ ABSOLUTE MAXIMUM RATINGS

Supply Voltage		12V
Shutdown Terminal Voltage		12V
Noise Bypass Terminal Voltage		5V
Operating Temperature Range		-40°C~85°C
Maximum Junction Temperature		125°C
Storage Temperature Range		65ºC~150ºC
Lead Temperature (Soldering, 10 sec)		260°C
Thermal Resistance Junction to Case	SOT-23-5	
Thermal Resistance Junction to Ambient	SOT-23-5	
(Assume no ambient airflow, no heatsink)		

Absolute Maximum Ratings are those values beyond which the life of a device may be impaired.

TEST CIRCUIT

Refer to TYPICAL APPLICATION CIRCUIT



# ELECTRICAL CHARACTERISTICS

# ( $C_{IN}$ =1 $\mu$ F, $C_{OUT}$ =10 $\mu$ F, $T_{J}$ =25°C, unless otherwise specified) (Note1)

PARAMETER	TEST CONDITIONS		SYMBOL	MIN.	TYP.	MAX.	UNIT
Quiescent Current	I <sub>OUT</sub> = 0mA, V <sub>IN</sub> = 3.6~12V		Ι <sub>Q</sub>		55	80	μA
Standby Current	V <sub>IN</sub> = 3.6~8V, output OFF		I <sub>STBY</sub>			0.1	μA
GND Pin Current	I <sub>OUT</sub> = 0.1~150mA		I <sub>GND</sub>		55	80	μΑ
Continuous Output Current	$V_{IN} = V_{OUT} + 1V$		I <sub>OUT</sub>			150	mA
Output Current Limit	$V_{IN} = V_{OUT} + 1V, V_{OUT} = 0$	VC	IIL	150	220		mA
Output Voltage Tolerance	$V_{IN} = V_{OUT} + 1V$ , no load		V <sub>OUT</sub>	-2		2	%
Temperature Coefficient			тс		50	150	ppm/⁰C
Line Regulation	$V_{IN} = V_{OUT(TYP)} + 1V$ to $V_{OUT(TYP)} + 6V$		$\Delta V_{LIR}$		2	7	mV
Load Regulation	V <sub>IN</sub> = 5V, I <sub>OUT</sub> = 0.1~150mA		$\Delta V_{LOR}$		7	25	mV
	I <sub>OUT</sub> = 50 mA				90	160	mV
Dropout Voltage (1)	I <sub>OUT</sub> = 100 mA V <sub>OUT</sub> ≥2.5	V	V		140	230	mV
	I <sub>OUT</sub> = 150 mA		V <sub>DROP1</sub>		200	350	mV
Dropout Voltage (2)	I <sub>OUT</sub> =150 mA V <sub>OUT</sub> <2.5	5V	V <sub>DROP2</sub>			700	mV
Noise Bypass Terminal Voltage			V <sub>REF</sub>		1.23		V
Output Noise	C <sub>BP</sub> = 0.1μF, f = 1KHz V <sub>IN</sub> = 5V		Δn		0.46		$\frac{\mu V}{\sqrt{Hz}}$
SHUTDOWN TERMINAL SPEC	FICATIONS						
Shutdown Pin Current			ISHDN			0.1	μA
Shutdown Pin Voltage (ON)	Output ON		V SHDN (ON)	1.6			V
Shutdown Pin Voltage (OFF)	Output OFF		V SHDN (OFF)			0.6	V
Shutdown Exit Delay Time	$C_{BP} = 0.1 \mu F, C_{OUT} = 1 \mu F,$ $I_{OUT}=30 m A$		Δt		300		μS
THERMAL PROTECTION							
Thermal Shutdown Temperature			T <sub>SD</sub>		155		٥C
Thermal Shutdown Hysteresis	Guaranteed by desig	n	T <sub>HYST</sub>		20		°C

**Note 1:** Specifications are production tested at TA=25°C. Specifications over the -40°C to 85°C operating temperature range are assured by design, characterization and correlation with Statistical Quality Controls (SQC).

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# TYPICAL PERFORMANCE CHARACTERISTICS





# TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

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# **TYPICAL PERFORMANCE CHARACTERISTICS (Continued)**



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Fig. 15 Ground Current vs. Input Voltage (V<sub>OUT</sub>=3.0V)





Fig. 16 Quiescent Current (ON Mode) vs. Input Voltage





# TYPICAL PERFORMANCE CHARACTERISTICS (Continued)



# BLOCK DIAGRAM





#### **PIN DESCRIPTIONS**

PIN 1 : VIN - Power supply input pin. Bypass
with a $1\mu F$ capacitor to GND
PIN 2 : GND - Ground pin.
PIN 3 : SHDN - Active-Low shutdown input pin.
PIN 4 : BP - Noise bypass pin. An external
bypass capacitor connecting to

# BP pin to reduce noises at the output.

PIN 5 : VOUT - Output pin. Sources up to 150 mA.

#### **DETAILED DESCRIPTION OF TECHNICAL TERMS**

#### DROPOUT VOLTAGE (VDROP)

The dropout voltage is defined as the difference between the input voltage and output voltage at which the output voltage drops 100mV. Below this value, the output voltage will fall as the input voltage reduces. It depends on the load current and junction temperature.

#### LINE REGULATION

Line regulation is the ability of the regulator to maintain a constant output voltage as the input voltage changes. The line regulation is specified as the input voltage changes from  $V_{IN} = V_{OUT} + 1V$  to  $V_{IN} = 8V$  and  $I_{OUT} = 1$ mA.

#### LOAD REGULATION

Load regulation is the ability of the regulator to maintain a constant output voltage as the load current changes. A pulsed measurement with an input voltage set to  $V_{IN} = V_{OUT} + V_{DROP}$  can minimize temperature effects. The load regulation is specified by the output current ranging from 0.1mA to 150mA.

#### QUIESCENT CURRENT (IQ)

Quiescent current is the current flowing through ground pin with no output load.

#### **GROUND CURRENT (IGND)**

Ground current is the current flowing through the ground pin with output load.

#### STANDBY CURRENT (ISTBY)

Standby current is the current flowing into the regulator when the output is shutdown by setting  $V_{SHDN}$  at 0V and  $V_{IN}$  at 8 V.

#### CURRENT LIMIT (IIL)

Current limiting of AIC1730 monitors and controls the maximum output current, in case of a shorted output. It protects device from the damage resulting from any unexpected current.

#### THERMAL PROTECTION

Thermal sensor protects device when the junction temperature exceeds  $T_{J}$ = +155°C. It signals shutdown logic, turning off pass transistor and allowing IC to cool down. After the IC's junction temperature cools by 20°C, the thermal sensor will turn the pass transistor back on. Thermal protection is designed to protect the device in the event of fault conditions. For a continuous operation, do not exceed the absolute maximum junction-temperature rating of  $T_{J}$ = 150°C, or damage may occur to the device.

### APPLICATION INFORMATION

#### **INPUT-OUTPUT CAPACITORS**

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Linear regulators require input and output capacitors to maintain stability. Input capacitor at  $1\mu$ F with 1uF aluminum electrolytic output capacitor is recommended. And it should be selected within the Equivalent Series Resistance (ESR) range as shown in the figure 21, 22, 23, and 24. ESR of ceramic capacitor is lower and its electrical characteristics (capacitance and ESR) vary widely over temperature. In general, tantalum or electric output capacitor is suggested for heavy load.

Normally, the output capacitor should be  $1\mu$ F (aluminum electrolytic) at least and rates for operating temperature range. Note that it's important to check selected manufactures electrical characteristics (capacitance and ESR) over temperature.

#### NOISE BYPASS CAPACITOR

0.1µF bypass capacitor at BP pin reduces output voltage noise. And the BP pin has to connect a capacitor to GND.

#### **POWER DISSIPATION**

The maximum power dissipation of AIC1742 depends on the thermal resistance of its case

and circuit board, the temperature difference between the die junction and ambient air, and the rate of airflow. The rate of temperature rise is greatly affected by the mounting pad configuration on the PCB, the board material, and the ambient temperature. When the IC mounting with good thermal conductivity is used, the junction temperature will be low even when large power dissipation applies.

The power dissipation across the device is  $P = I_{OUT} (V_{IN}-V_{OUT}).$ The maximum power dissipation is:

 $P_{MAX} = \frac{(T_J - T_A)}{(R\theta_{JB} + R\theta_{BA})}$ 

Where  $T_J-T_A$  is the temperature difference between the die junction and the surrounding air,  $R\theta_{JB}$  is the thermal resistance of the package, and  $R\theta_{BA}$  is the thermal resistance through the PCB, copper traces, and other materials to the surrounding air.

As a general rule, the lower temperature is, the better reliability of the device is. So the PCB mounting pad should provide maximum thermal conductivity to maintain low device temperature. GND pin performs a dual function of providing an electrical connection to ground and channeling heat away. Therefore, connecting the

GND pin to ground with a large pad or ground plane would increase the power dissipation and reduce the device temperature.

# AIC1730







#### PHYSICAL DIMENSIONS

• SOT-23-5 (unit: mm)



Note : 1. Refer to JEDEC MO-178AA.

- Dimension "D" does not include mold flash, protrusions or gate burrs. Mold flash, protrusion or gate burrs shall not exceed 10 mil per side.
- 3. Dimension "E1" does not include inter-lead flash or protrusions.
- 4. Controlling dimension is millimeter, converted inch dimensions are not necessarily exact.

#### Note:

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